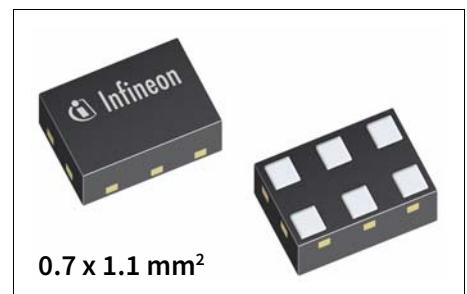


# BGA824N6

## Silicon Germanium Low Noise Amplifier for Global Navigation Satellite Systems (GNSS)

### Features

- Operating frequencies: 1164 - 1615 MHz
- Insertion power gain: 17.0 dB
- Input 1 dB compression point: -6 dBm
- Low noise figure: 0.55 dB
- Low current consumption: 3.8 mA
- Digital on/off switch
- Ultra small TSNP-6-2 and TSNP-6-10 leadless package
- RF output internally matched to 50 Ohm
- Low external component count



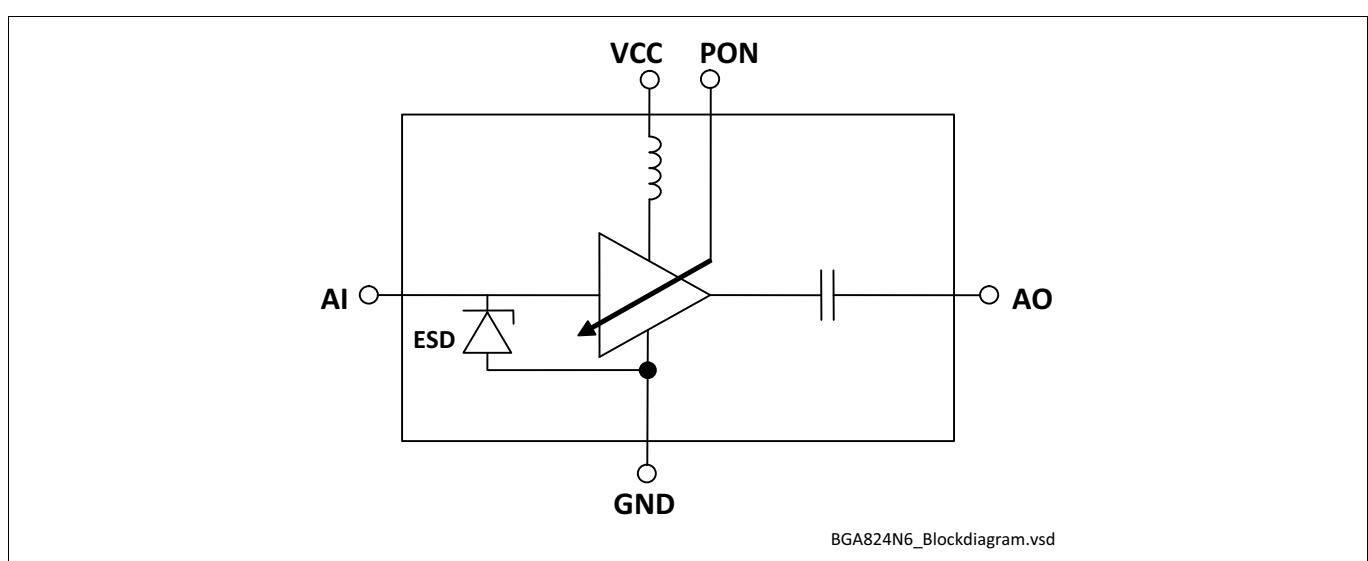
### Application

Ideal for all Global Navigation Satellite Systems (GNSS) like GPS, GLONASS, Beidou, Galileo and others.

### Product Validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

### Block diagram

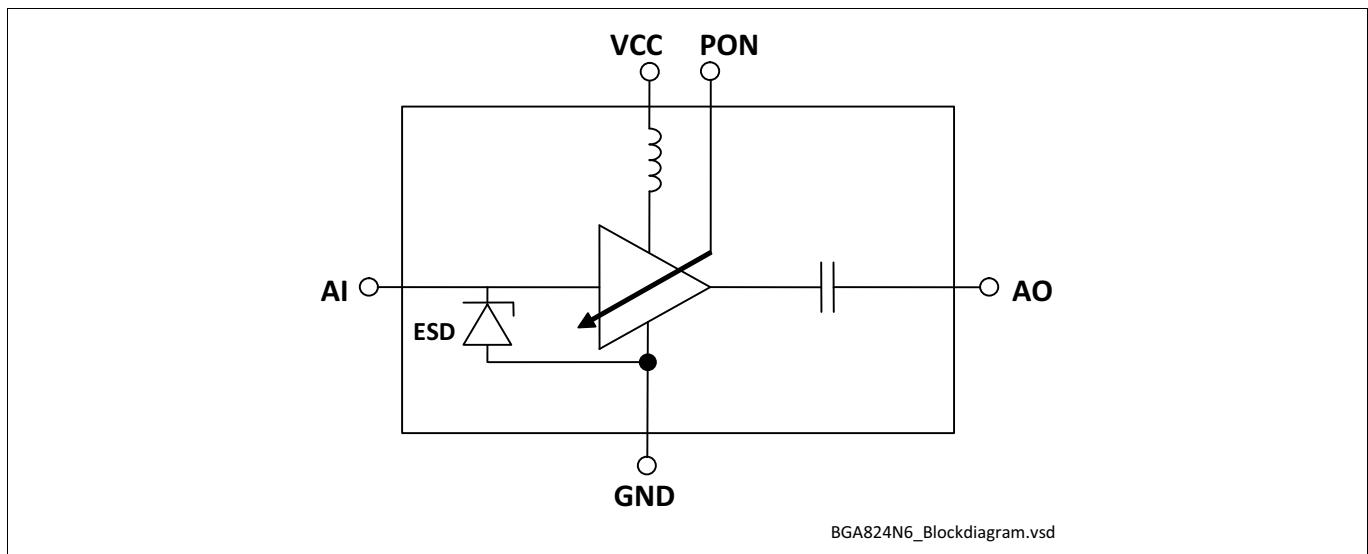


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**Features****1 Features**

- Insertion power gain: 17.0 dB
- Out-of-band input 3rd order intercept point: +7 dBm
- Input 1 dB compression point: -6 dBm
- Low noise figure: 0.55 dB
- Low current consumption: 3.8 mA
- Operating frequencies: 1164 - 1615 MHz
- Digital on/off switch
- Supply voltage: 1.5 V to 3.6 V
- Ultra small TSNP-6-2 and TSNP-6-10 leadless package (footprint: 0.7 x 1.1 mm<sup>2</sup>)
- B7HF Silicon Germanium technology
- RF output internally matched to 50 Ohm
- Low external component count
- 2kV HBM ESD protection (including AI-pin)
- Pb-free (RoHS compliant) package

**Figure 1 Block Diagram**

Product Name	Marking	Package
BGA824N6	F	TSNP-6-2/TSNP-6-10

**Features****Description**

The BGA824N6 is a front-end low noise amplifier for Global Navigation Satellite Systems (GNSS) from 1164 MHz to 1615 MHz like GPS, GLONASS, Beidou, Galileo and others. The LNA provides 17.0 dB gain and 0.55 dB noise figure at a current consumption of 3.8 mA in the application configuration described in [Chapter 4](#). The BGA824N6 is based upon Infineon Technologies' B7HF Silicon Germanium technology. It operates from 1.5 V to 3.6 V supply voltage.

**Pin Definition and Function****Table 1 Pin Definition and Function**

Pin No.	Name	Function
1	GND	Ground
2	VCC	DC supply
3	AO	LNA output
4	GND	Ground
5	AI	LNA input
6	PON	Power on control

**Maximum Ratings****2 Maximum Ratings****Table 2 Maximum Ratings**

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Voltage at pin VCC	$V_{CC}$	-0.3	-	3.6	V	1)
Voltage at pin AI	$V_{AI}$	-0.3	-	0.9	V	-
Voltage at pin AO	$V_{AO}$	-0.3	-	$V_{CC} + 0.3$	V	-
Voltage at pin PON	$V_{PON}$	-0.3	-	$V_{CC} + 0.3$	V	-
Voltage at pin GNDRF	$V_{GNDRF}$	-0.3	-	0.3	V	-
Current into pin VCC	$I_{CC}$	-	-	23	mA	-
RF input power	$P_{IN}$	-	-	25	dBm	-
Total power dissipation, $T_S < 148 \text{ }^{\circ}\text{C}^2$	$P_{tot}$	-	-	60	mW	-
Junction temperature	$T_J$	-	-	150	$^{\circ}\text{C}$	-
Ambient temperature range	$T_A$	-40	-	85	$^{\circ}\text{C}$	-
Storage temperature range	$T_{STG}$	-55	-	150	$^{\circ}\text{C}$	-
ESD capability all pins	$V_{ESD\_HBM}$	-2000	-	+2000	V	according to JS-001

1) All voltages refer to GND-Node unless otherwise noted

2)  $T_S$  is measured on the ground lead at the soldering point

**Attention:** *Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.*

**Thermal Resistance****Table 3 Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	25	K/W

1) For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

## Electrical Characteristics

## 3 Electrical Characteristics

**Table 4 Electrical Characteristics f = 1550 - 1615 MHz, V<sub>CC</sub> = 1.8V<sup>1)</sup>**T<sub>A</sub> = 25 °C, V<sub>CC</sub> = 1.8 V, V<sub>PON,ON</sub> = 1.8 V, V<sub>PON,OFF</sub> = 0 V, f = 1550 - 1615 MHz

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply voltage	V <sub>CC</sub>	1.5	1.8	3.6	V	-
Supply current	I <sub>CC</sub>	-	3.8	4.8	mA	ON-mode
		-	0.2	3	μA	OFF-mode
Power On voltage	V <sub>PON</sub>	0.8	-	Vcc	V	ON-mode
		0	-	0.4	V	OFF-mode
Power On current	I <sub>PON</sub>	-	5	10	μA	ON-mode
		-	-	1	μA	OFF-mode
Insertion power gain f = 1575 MHz	S <sub>21</sub>   <sup>2</sup>	16.0	17.0	18.0	dB	-
Noise figure <sup>2)</sup> f = 1575 MHz	NF	-	0.55	1.1	dB	-
Input return loss <sup>3)</sup> f = 1575 MHz	R <sub>LIN</sub>	10	14	-	dB	-
Output return loss <sup>3)</sup> f = 1575 MHz	R <sub>LOUT</sub>	10	17	-	dB	-
Reverse isolation <sup>3)</sup> f = 1575 MHz	1/ S <sub>12</sub>   <sup>2</sup>	19	23	-	dB	-
Power gain settling time <sup>4)5)</sup>	t <sub>S</sub>	-	5	8	μs	OFF- to ON-mode
		-	5	8	μs	ON- to OFF-mode
		-	1.2	3	μs	OFF- to ON-mode <sup>6)</sup>
		-	0.9	3	μs	ON- to OFF-mode <sup>6)</sup>
Inband input 1dB-compression point <sup>3)</sup> f = 1575 MHz	I <sub>P1dB</sub>	-13	-9	-	dBm	-
Inband input 3 <sup>rd</sup> -order intercept point <sup>3)7)</sup>	IIP <sub>3</sub>	-3	+2	-	dBm	f <sub>1</sub> = 1575 MHz f <sub>2</sub> = f <sub>1</sub> +/- 1 MHz
Out-of-band input 3 <sup>rd</sup> -order intercept point <sup>5)8)</sup>	IIP <sub>300B</sub>	+2	+7	-	dBm	f <sub>1</sub> = 1712.7 MHz f <sub>2</sub> = 1850 MHz
Stability <sup>5)</sup>	k	> 1	-	-		f = 20 MHz ... 10 GHz

1) Based on the application described in Figure 2 in [Chapter 4](#)

2) PCB losses are subtracted

3) Verification based on AQL; not 100% tested in production

4) To be within 1 dB of the final gain OFF- to ON-mode; to be within 3 dB of the final gain ON- to OFF-mode

5) Guaranteed by device design; not tested in production

6) 120 pF DC block capacitor at RF input

7) Input power = -30 dBm for each tone

8) Input power = -20 dBm for each tone

## Electrical Characteristics

**Table 5 Electrical Characteristics f = 1550 - 1615 MHz, V<sub>CC</sub> = 2.8V<sup>1)</sup>**T<sub>A</sub> = 25 °C, V<sub>CC</sub> = 2.8 V, V<sub>PON,ON</sub> = 2.8 V, V<sub>PON,OFF</sub> = 0 V, f = 1550 - 1615 MHz

<b>Parameter</b>	<b>Symbol</b>	<b>Values</b>			<b>Unit</b>	<b>Note or Test Condition</b>
		<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>		
Supply voltage	V <sub>CC</sub>	1.5	2.8	3.6	V	-
Supply current	I <sub>CC</sub>	-	3.9	4.9	mA	ON-mode
		-	0.2	3	μA	OFF-mode
Power On voltage	V <sub>PON</sub>	0.8	-	Vcc	V	ON-mode
		0	-	0.4	V	OFF-mode
Power On current	I <sub>PON</sub>	-	10	15	μA	ON-mode
		-	-	1	μA	OFF-mode
Insertion power gain f = 1575 MHz	S <sub>21</sub>   <sup>2</sup>	16.1	17.1	18.1	dB	-
Noise figure <sup>2)</sup> f = 1575 MHz	NF	-	0.55	1.1	dB	-
Input return loss <sup>3)</sup> f = 1575 MHz	R <sub>LIN</sub>	10	15	-	dB	-
Output return loss <sup>3)</sup> f = 1575 MHz	R <sub>LOUT</sub>	10	18	-	dB	-
Reverse isolation <sup>3)</sup> f = 1575 MHz	1/ S <sub>12</sub>   <sup>2</sup>	19	23	-	dB	-
Power gain settling time <sup>4)5)</sup>	t <sub>S</sub>	-	5	8	μs	OFF- to ON-mode
		-	5	8	μs	ON- to OFF-mode
		-	1.2	3	μs	OFF- to ON-mode <sup>6)</sup>
		-	0.9	3	μs	ON- to OFF-mode <sup>6)</sup>
Inband input 1dB-compression point <sup>3)</sup> f = 1575 MHz	I <sub>P1dB</sub>	-10	-6	-	dBm	-
Inband input 3 <sup>rd</sup> -order intercept point <sup>3)7)</sup>	IIP <sub>3</sub>	-2	+3	-	dBm	f <sub>1</sub> = 1575 MHz f <sub>2</sub> = f <sub>1</sub> +/- 1 MHz
Out-of-band input 3 <sup>rd</sup> -order intercept point <sup>5)8)</sup>	IIP <sub>300B</sub>	+2	+7	-	dBm	f <sub>1</sub> = 1712.7 MHz f <sub>2</sub> = 1850 MHz
Stability <sup>5)</sup>	k	> 1	-	-		f = 20 MHz ... 10 GHz

1) Based on the application described in Figure 2 in [Chapter 4](#)

2) PCB losses are subtracted

3) Verification based on AQL; not 100% tested in production

4) To be within 1 dB of the final gain OFF- to ON-mode; to be within 3 dB of the final gain ON- to OFF-mode

5) Guaranteed by device design; not tested in production

6) 120 pF DC block capacitor at RF input

7) Input power = -30 dBm for each tone

8) Input power = -20 dBm for each tone

## Electrical Characteristics

**Table 6 Electrical Characteristics  $f = 1164 - 1300 \text{ MHz}$ ,  $V_{CC} = 1.8 \text{ V}^1)$**  $T_A = 25^\circ \text{C}$ ,  $V_{CC} = 1.8 \text{ V}$ ,  $V_{PON,ON} = 1.8 \text{ V}$ ,  $V_{PON,OFF} = 0 \text{ V}$ ,  $f = 1164 - 1300 \text{ MHz}$ 

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_{CC}$	1.5	1.8	3.6	V	-
Supply current	$I_{CC}$	-	3.8	4.8	mA	ON-mode
		-	0.2	3	μA	OFF-mode
Power On voltage	$V_{PON}$	0.8	-	Vcc	V	ON-mode
		0	-	0.4	V	OFF-mode
Power On current	$I_{PON}$	-	5	10	μA	ON-mode
		-	-	1	μA	OFF-mode
Insertion power gain $f = 1214 \text{ MHz}$	$ S_{21} ^2$	16.4	17.9	19.4	dB	-
Noise figure <sup>2)</sup> $f = 1214 \text{ MHz}$	$NF$	-	0.70	1.25	dB	-
Input return loss <sup>3)</sup> $f = 1214 \text{ MHz}$	$RL_{IN}$	10	15	-	dB	-
Output return loss <sup>3)</sup> $f = 1214 \text{ MHz}$	$RL_{OUT}$	10	18	-	dB	-
Reverse isolation <sup>3)</sup> $f = 1214 \text{ MHz}$	$1/ S_{12} ^2$	19	25	-	dB	-
Power gain settling time <sup>4)5)</sup>	$t_S$	-	5	8	μs	OFF- to ON-mode
		-	5	8	μs	ON- to OFF-mode
		-	1.2	3	μs	OFF- to ON-mode <sup>6)</sup>
		-	0.9	3	μs	ON- to OFF-mode <sup>6)</sup>
Inband input 1dB-compression point <sup>3)</sup> $f = 1214 \text{ MHz}$	$IP_{1\text{dB}}$	-16	-12	-	dBm	-
Inband input 3 <sup>rd</sup> -order intercept point <sup>3)7)</sup>	$IIP_3$	-11	-6	-	dBm	$f_1 = 1214 \text{ MHz}$ $f_2 = f_1 +/- 1 \text{ MHz}$
Out-of-band input 3 <sup>rd</sup> -order intercept point <sup>5)8)</sup>	$IIP_{300B}$	-3	+1.3	-	dBm	$f_1 = 1850 \text{ MHz}$ $f_2 = 2500 \text{ MHz}$
Stability <sup>5)</sup>	$k$	> 1	-	-		$f = 20 \text{ MHz} \dots 10 \text{ GHz}$

1) Based on the application described in Figure 3 in [Chapter 4](#)

2) PCB losses are subtracted

3) Verification based on AQL; not 100% tested in production

4) To be within 1 dB of the final gain OFF- to ON-mode; to be within 3 dB of the final gain ON- to OFF-mode

5) Guaranteed by device design; not tested in production

6) 120 pF DC block capacitor at RF input

7) Input power = -30 dBm for each tone

8) Input power = -25 dBm for each tone

## Electrical Characteristics

**Table 7 Electrical Characteristics f = 1164 - 1300 MHz, V<sub>CC</sub> = 2.8V<sup>1)</sup>**T<sub>A</sub> = 25 °C, V<sub>CC</sub> = 2.8 V, V<sub>PON,ON</sub> = 2.8 V, V<sub>PON,OFF</sub> = 0 V, f = 1164 - 1300 MHz

<b>Parameter</b>	<b>Symbol</b>	<b>Values</b>			<b>Unit</b>	<b>Note or Test Condition</b>
		<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>		
Supply voltage	V <sub>CC</sub>	1.5	2.8	3.6	V	-
Supply current	I <sub>CC</sub>	-	3.9	4.8	mA	ON-mode
		-	0.2	3	μA	OFF-mode
Power On voltage	V <sub>PON</sub>	0.8	-	Vcc	V	ON-mode
		0	-	0.4	V	OFF-mode
Power On current	I <sub>PON</sub>	-	10	15	μA	ON-mode
		-	-	1	μA	OFF-mode
Insertion power gain f = 1214 MHz	S <sub>21</sub>   <sup>2</sup>	16.5	18.0	19.5	dB	-
Noise figure <sup>2)</sup> f = 1214 MHz	NF	-	0.70	1.25	dB	-
Input return loss <sup>3)</sup> f = 1214 MHz	RL <sub>IN</sub>	10	16	-	dB	-
Output return loss <sup>3)</sup> f = 1214 MHz	RL <sub>OUT</sub>	10	18	-	dB	-
Reverse isolation <sup>3)</sup> f = 1214 MHz	1/ S <sub>12</sub>   <sup>2</sup>	19	26	-	dB	-
Power gain settling time <sup>4)5)</sup>	t <sub>S</sub>	-	5	8	μs	OFF- to ON-mode
		-	5	8	μs	ON- to OFF-mode
		-	1.2	3	μs	OFF- to ON-mode <sup>6)</sup>
		-	0.9	3	μs	ON- to OFF-mode <sup>6)</sup>
Inband input 1dB-compression point <sup>3)</sup> f = 1214 MHz	I <sub>P1dB</sub>	-13	-9	-	dBm	-
Inband input 3 <sup>rd</sup> -order intercept point <sup>3)7)</sup>	IIP <sub>3</sub>	-10	-5	-	dBm	f <sub>1</sub> = 1214 MHz f <sub>2</sub> = f <sub>1</sub> +/- 1 MHz
Out-of-band input 3 <sup>rd</sup> -order intercept point <sup>5)8)</sup>	IIP <sub>300B</sub>	-3	+1.3	-	dBm	f <sub>1</sub> = 1850 MHz f <sub>2</sub> = 2500 MHz
Stability <sup>5)</sup>	k	> 1	-	-		f = 20 MHz ... 10 GHz

1) Based on the application described in Figure 3 in [Chapter 4](#)

2) PCB losses are subtracted

3) Verification based on AQL; not 100% tested in production

4) To be within 1 dB of the final gain OFF- to ON-mode; to be within 3 dB of the final gain ON- to OFF-mode

5) Guaranteed by device design; not tested in production

6) 120 pF DC block capacitor at RF input

7) Input power = -30 dBm for each tone

8) Input power = -25 dBm for each tone

## Application Information

## 4 Application Information

## Application Board Configuration f = 1550 - 1615 MHz

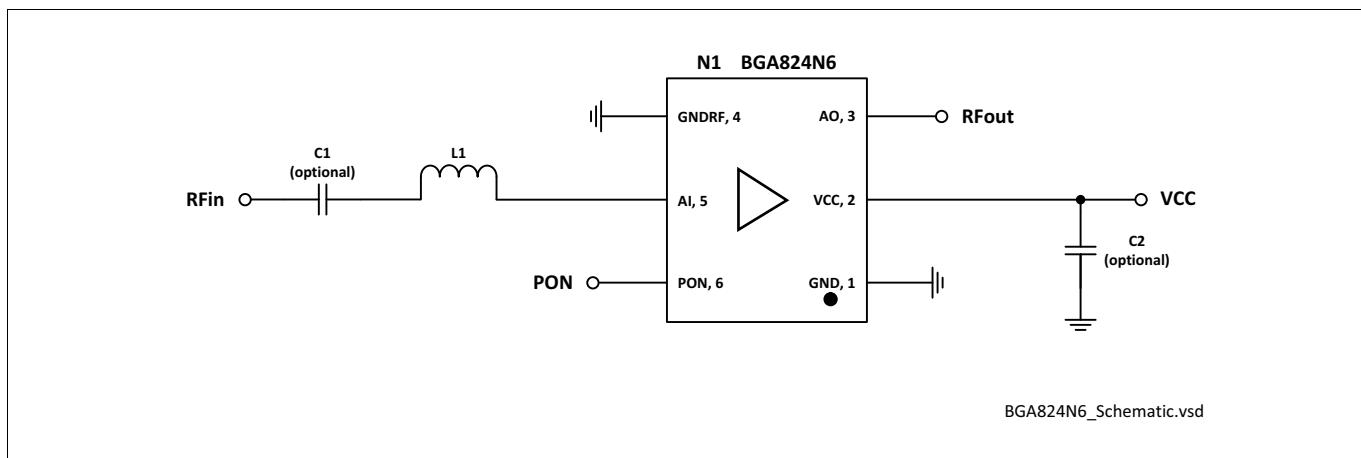


Figure 2 Application Schematic BGA824N6 f = 1550 - 1615 MHz

Table 8 Bill of Materials

Name	Value	Package	Manufacturer	Function
C1 (optional)	1nF	0402	Various	DC block <sup>1)</sup>
C2 (optional)	$\geq 10\text{nF}^2)$	0402	Various	RF bypass <sup>3)</sup>
L1	6.8nH	0402	Murata LQW type	Input matching
N1	BGA824N6	TSNP-6-2 and TSNP-6-10	Infineon	SiGe LNA

1) DC block might be realized with pre-filter in GNSS application

2) For data sheet characteristics 1 $\mu\text{F}$  used

3) RF bypass recommended to mitigate power supply noise

A list of all application notes is available at <http://www.infineon.com/gpslna.appnotes>

## Application Information

## Application Board Configuration f = 1164 - 1300 MHz

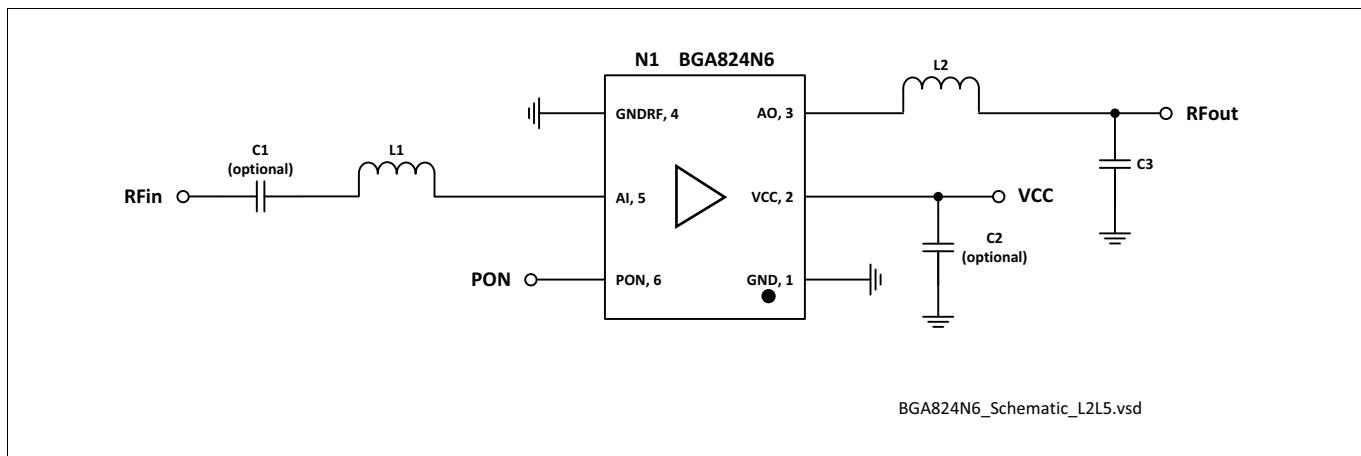


Figure 3 Application Schematic BGA824N6 f = 1164 - 1300 MHz

Table 9 Bill of Materials

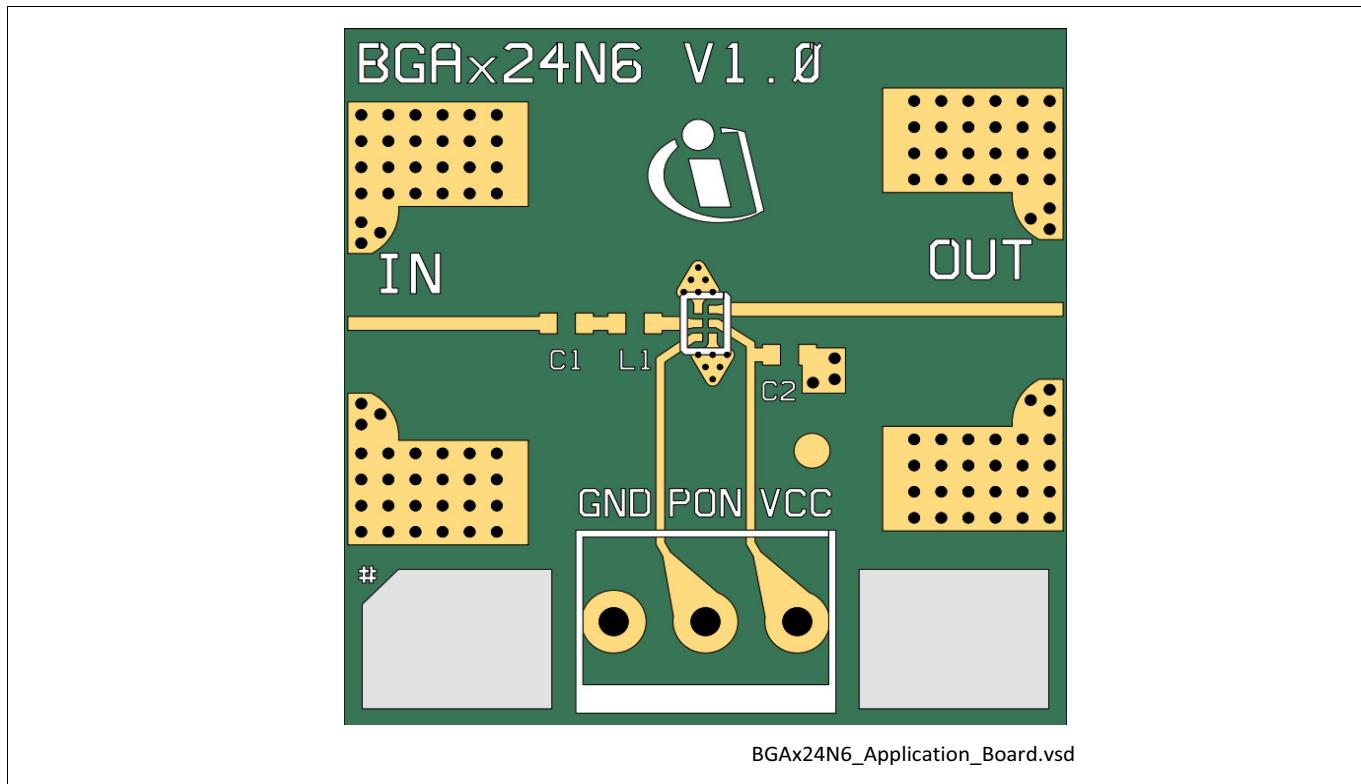
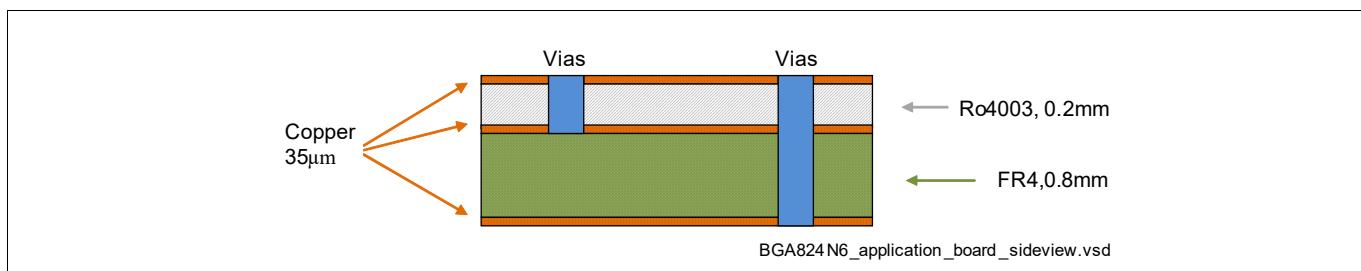
Name	Value	Package	Manufacturer	Function
C1 (optional)	1nF	0402	Various	DC block <sup>1)</sup>
C2 (optional)	$\geq 10nF^2)$	0402	Various	RF bypass <sup>3)</sup>
C3	3.9pF	0402	Various	Output matching
L1	12nH	0402	Murata LQW type	Input matching
L2	3.9nH	0402	Murata LQW type	Output matching
N1	BGA824N6	TSNP-6-2 and TSNP-6-10	Infineon	SiGe LNA

1) DC block might be realized with pre-filter in GNSS application

2) For data sheet characteristics 1 $\mu$ F used

3) RF bypass recommended to mitigate power supply noise

A list of all application notes is available at <http://www.infineon.com/gpslna.appnotes>

**Application Information****Figure 4 Drawing of Application Board****Figure 5 Application Board Cross-Section**

## Package Information

## 5 Package Information

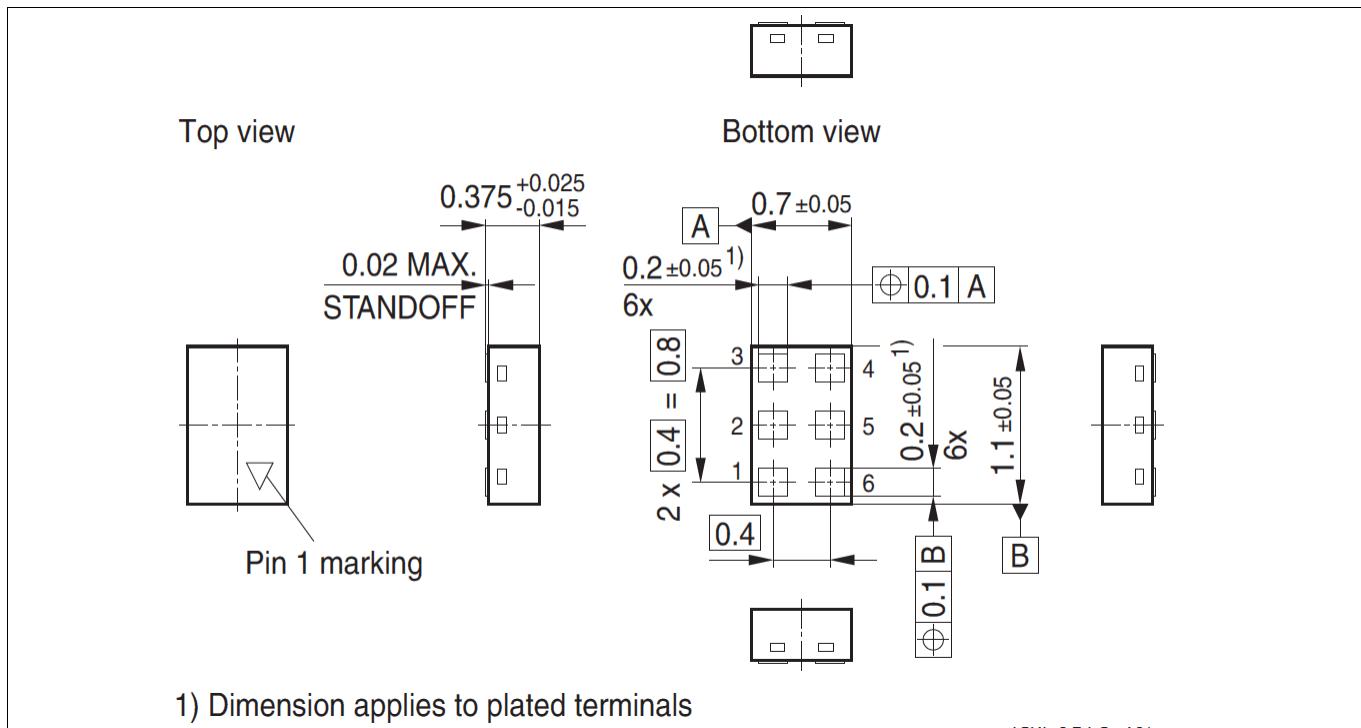


Figure 6 TSNP-6-2 Package Outline (top, side and bottom views)

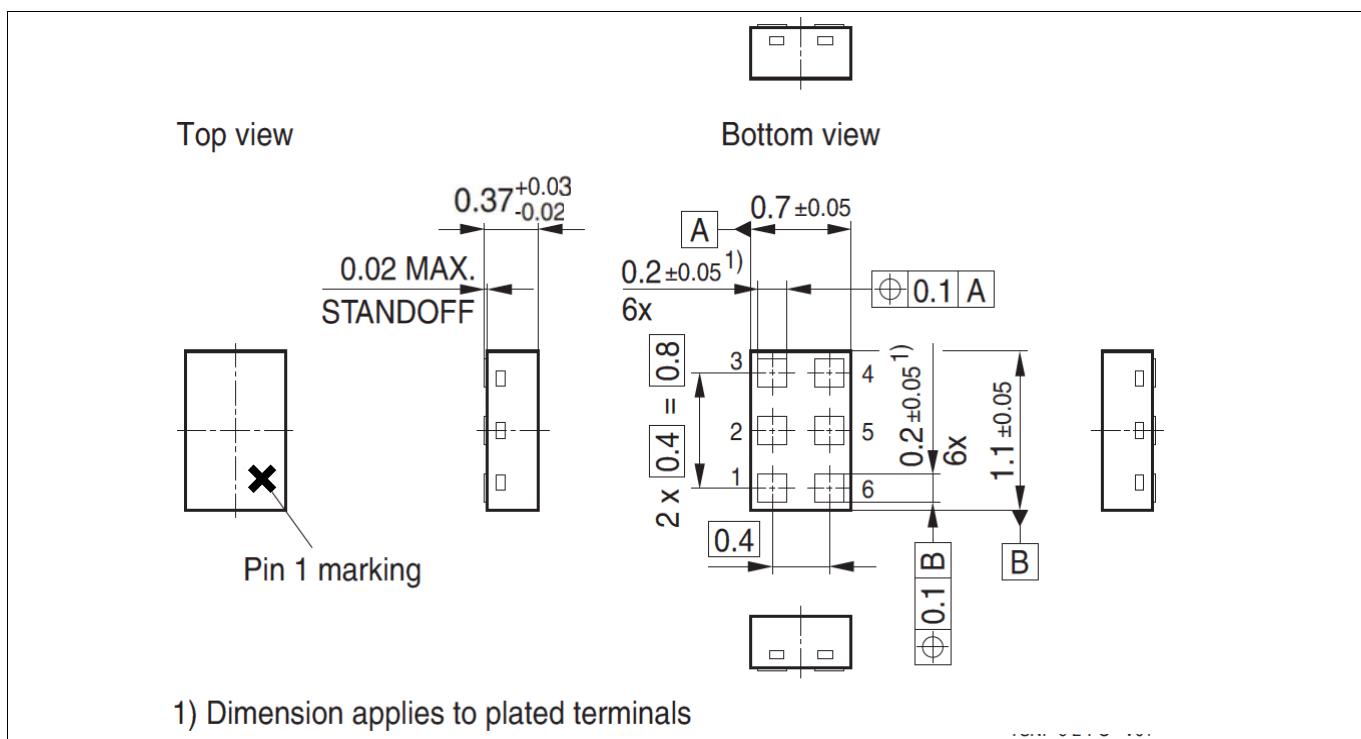
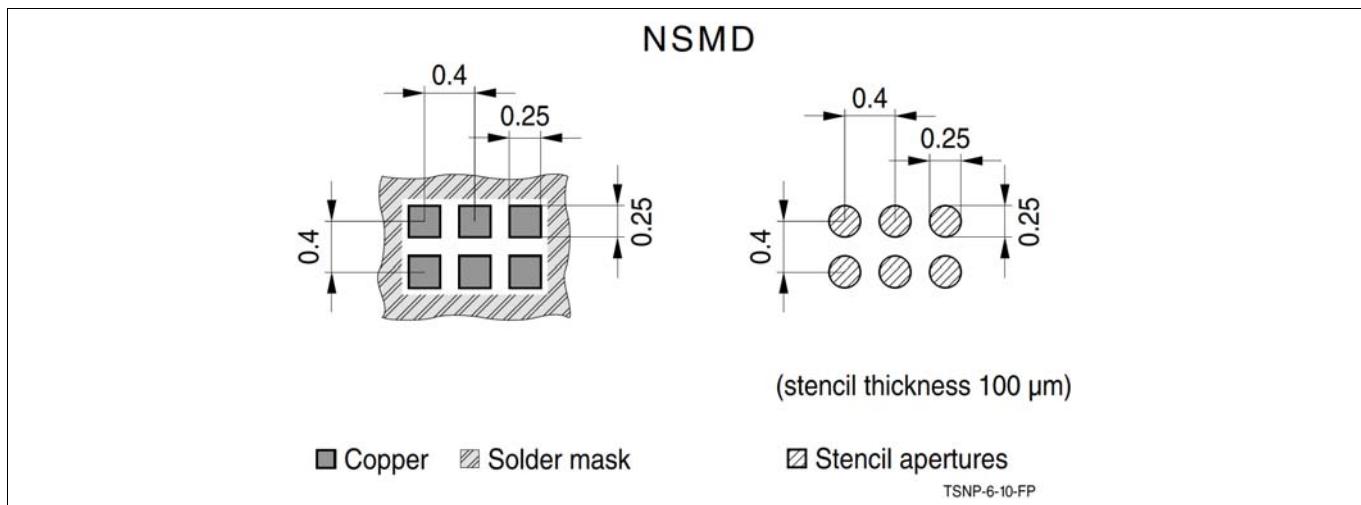
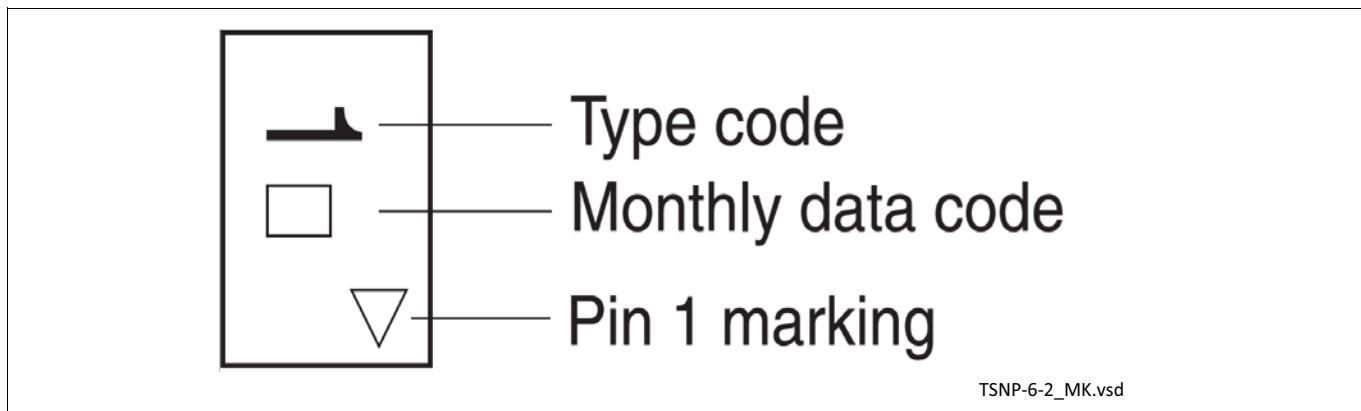
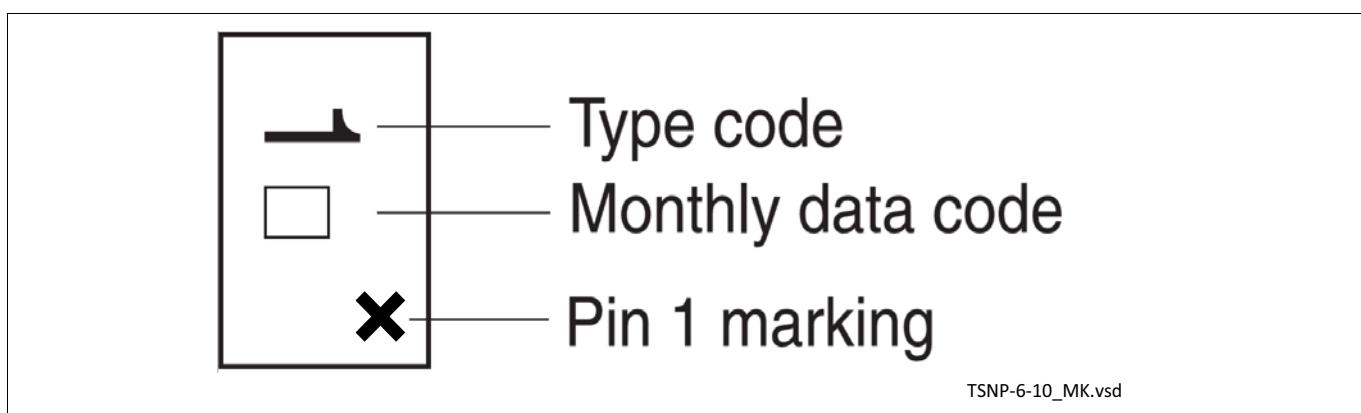


Figure 7 TSNP-6-10 Package Outline (top, side and bottom views)

**Package Information****Figure 8** Footprint Recommendation TSNP-6-2 and TSNP-6-10**Figure 9** Marking Layout TSNP-6-2 (top view)**Figure 10** Marking Layout TSNP-6-10 (top view)

## Package Information

Month	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

Figure 11 Date Code Marking TSNP-6-2 and TSNP-6-10

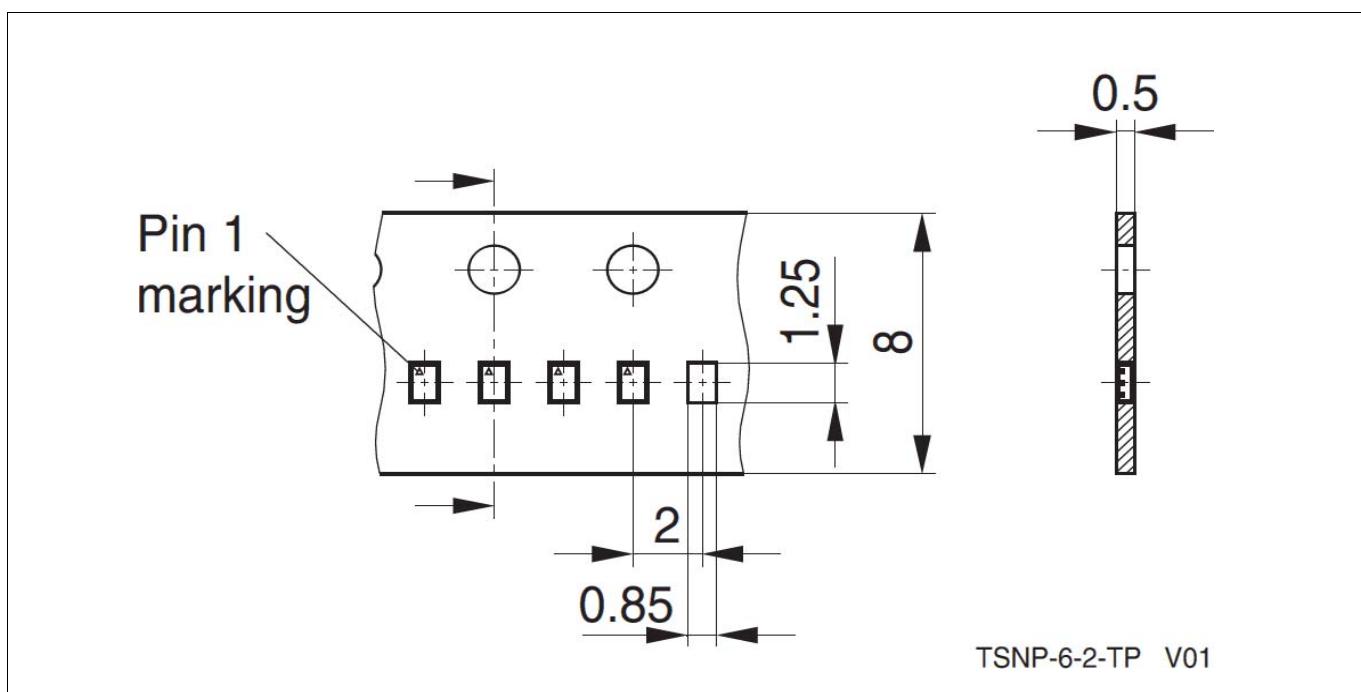


Figure 12 Tape &amp; Reel Dimensions TSNP-6-2 (reel diameter 180 mm, pieces/reel 15000)

## Package Information

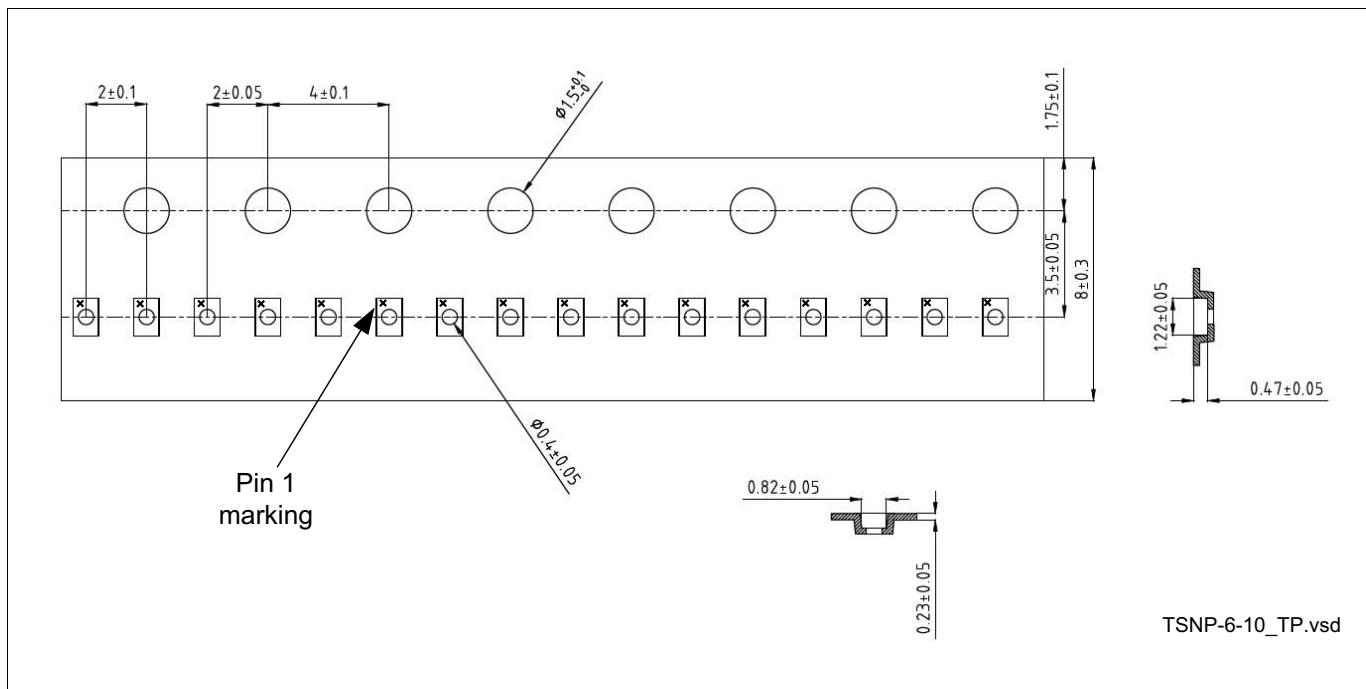


Figure 13 Tape & Reel Dimensions TSNP-6-10 (reel diameter 180 mm, pieces/reel 12000)

**Revision History**

Page or Item	Subjects (major changes since previous revision)
<b>Revision 3.5, 2023-01-12</b>	
6-9	Update Power On Voltage in On-Mode

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**Email: [erratum@infineon.com](mailto:erratum@infineon.com)**

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